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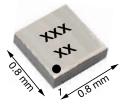
Si8805EDB



P-Channel 8 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (TYP.)		
-8	0.068 at V_{GS} = -4.5 V	-3.1			
	0.088 at V_{GS} = -2.5 V	-2.7	6.7 nC		
	0.155 at V _{GS} = -1.5 V	-2.1	0.7 110		
	0.290 at V _{GS} = -1.2 V	-0.5			

MICRO FOOT® 0.8 x 0.8





Backside View

Bump Side View

Marking Code: xx = AC xxx = Date/Lot traceability code

Ordering Information:

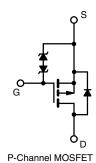
Si8805EDB-T2-E1 (lead (Pb)-free and halogen-free)

FEATURES

- TrenchFET[®] power MOSFET
- Ultra small 0.8 mm x 0.8 mm outline
- Ultra thin 0.357 mm height
- Typical ESD protection 1500 V HBM
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Portable devices such as cell phones, smart phones, tablet PCs, and media players
- Load switch for low voltage gate drive
- Load switch for 1.2 V power line



PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-8	V	
Gate-Source Voltage		V _{GS}	± 5	V	
	T _A = 25 °C		-3.1 ^a		
Continuous Drain Current (T 150 °C)	T _A = 70 °C		-2.5 ^a		
Continuous Drain Current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	-2.2 ^b		
	T _A = 70 °C	1	-1.8 ^b	A	
Pulsed Drain Current		I _{DM}	-15		
Continuos Course Ducia Dia da Cument	T _A = 25 °C		-0.7 ª		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	-0.4 ^b		
	T _A = 25 °C		0.9 ^a		
Martine as Decision Distribution	T _A = 70 °C		0.6 ^a	14/	
Maximum Power Dissipation	T _A = 25 °C	P _D	0.5 ^b	W	
	T _A = 70 °C		0.3 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150		
Soldering Recommendations (Peak Temperature) ^c		-	260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient a, d	t < 5 o	R _{thJA}	105	135	°C/W	
Maximum Junction-to-Ambient b, e	t≤5s		200	260	C/W	

Notes

a. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s.

b. Surface mounted on 1" x 1" FR4 board with minimum copper, t = 5 s.

c. Refer to IPC/JEDEC® (J-STD-020), no manual or hand soldering.

d. Maximum under steady state conditions is 185 °C/W.

e. Maximum under steady state conditions is 330 °C/W.

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Document Number: 67935

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-8	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	ln = -250 μΑ	-	-4	-	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	2.1	-		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.35	-	-0.7	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 5 V$	-	-	± 1.5		
Zara Cata Valtaga Drain Current	I	$V_{DS} = -8 V, V_{GS} = 0 V$	-	-	-1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -8 V, V_{GS} = 0 V, T_{J} = 55 \ ^{\circ}C$	-	-	-10		
On-State Drain Current ^a			-5	-	-	А	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -1.5 \text{ A}$	-	0.056	0.068		
Drain Sauraa On State Desistance 8	Р	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -1.5 \text{ A}$	-	0.070	0.088	- Ω - S	
Prain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$	-	0.115	0.155	5	
		V _{GS} = -1.2 V, I _D = -0.3 A	-	0.190	0.290		
Forward Transconductance ^a	g _{fs}	$V_{DS} = -4 V, I_D = -1.5 A$	-	8	-	S	
Dynamic ^b							
Total Gate Charge	Qg		-	6.7	10		
Gate-Source Charge	Q _{gs}	$V_{DS} = -4 V$, $V_{GS} = -4.5 V$, $I_D = -1.5 A$	-	0.7	-	nC	
Gate-Drain Charge	Q _{gd}		-	1.8	-		
Gate Resistance	R _g	f = 1 MHz	-	10	-	Ω	
Turn-On Delay Time	t _{d(on)}		-	13	25		
Rise Time	t _r	$V_{DD} = -4 V, R_{L} = 2.7 \Omega$	-	13	25		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ -1.5 A, V_GEN = -4.5 V, R_g = 1 Ω	-	25	50	ns	
Fall Time	t _f		-	17	35		
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	-0.7	•	
Pulse Diode Forward Current	I _{SM}	-		-	-15	A	
Body Diode Voltage	V _{SD}	$I_{\rm S}$ = -1.5 A, $V_{\rm GS}$ = 0 V	-	-0.8	-1.2	V	
Body Diode Reverse Recovery Time	t _{rr}		-	35	70	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = -1.5 A,	-	15	30	nC	
Reverse Recovery Fall Time	t _a	dl/dt = 100 A/µs, T _J = 25 °C	-	15	-		
everse Recovery Rise Time t _b			-	20	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

T_J = 25 °C

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

$0.5 \qquad 0.5 \qquad 0 \qquad 0.5 \qquad 0 \qquad 0 \qquad 3 \qquad 6 \qquad 9 \qquad 12 \qquad 15 \qquad V_{GS} - Gate-Source Voltage (V)$

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3.0

2.5

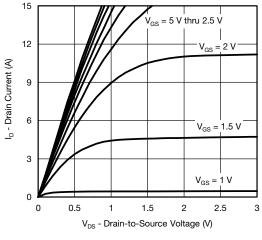
2.0

1.5

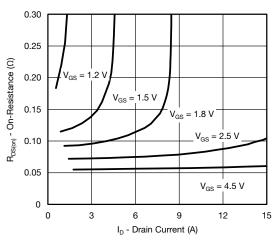
1.0

I_{GSS} - Gate Current (mA)

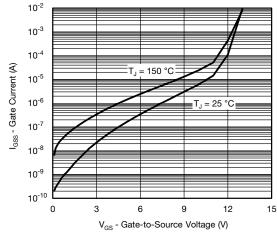




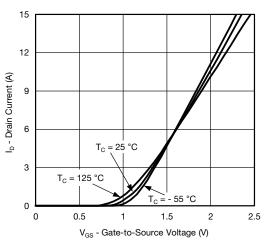
Output Characteristics



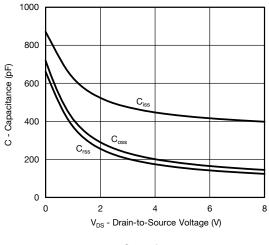
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



Transfer Characteristics



Capacitance

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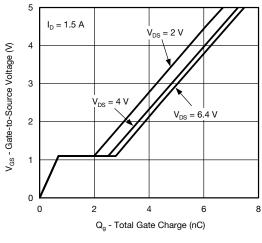
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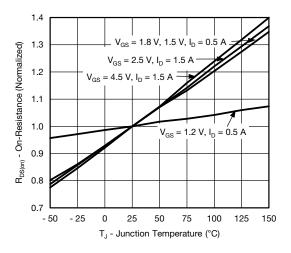


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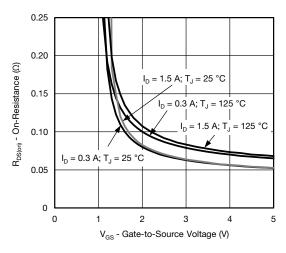
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



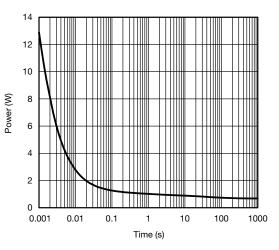
Gate Charge



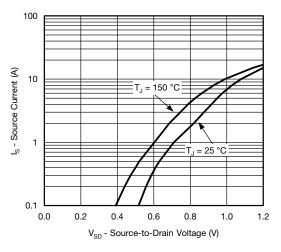
On-Resistance vs. Junction Temperature



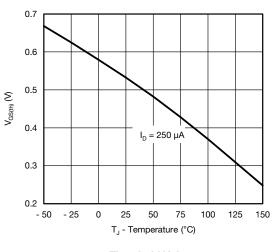
On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



Source-Drain Diode Forward Voltage



Threshold Voltage

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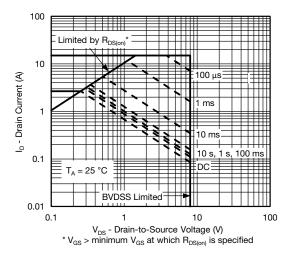
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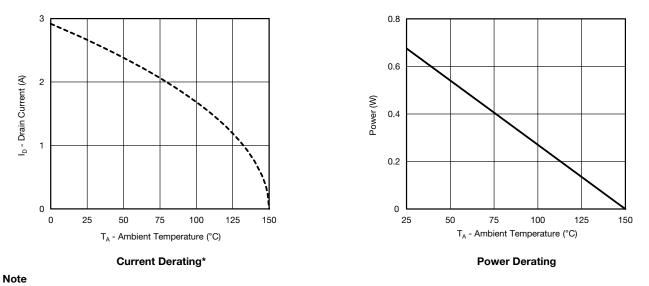


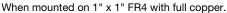
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient





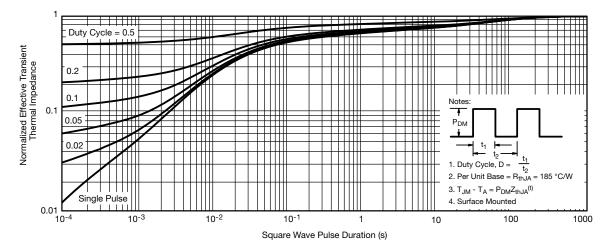
* The power dissipation P_D is based on $T_{J (max.)} = 150 \text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



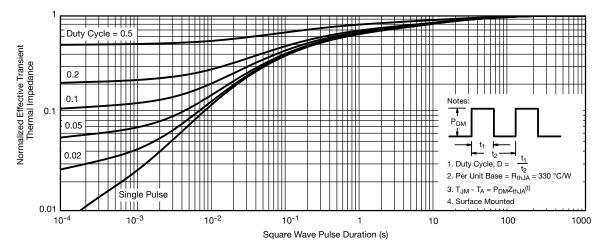
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient (On 1" x 1" FR4 Board with Maximum Copper)



Normalized Thermal Transient Impedance, Junction-to-Ambient (On 1" x 1" FR4 Board with Minimum Copper)

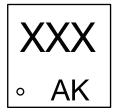
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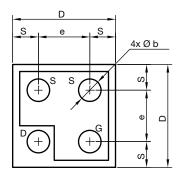


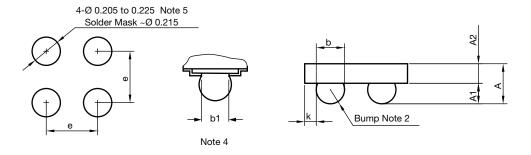
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MICRO FOOT®: 4-Bump (0.8 mm x 0.8 mm, 0.4 mm Pitch)









Notes

⁽¹⁾ Laser mark on the backside surface of die

⁽²⁾ Bumps are 95.5 % Sn,3.8 % Ag,0.7 % Cu

⁽³⁾ "i" is the location of pin 1

⁽⁴⁾ "b1" is the diameter of the solderable substrate surface, defined by an opening in the solder resist layer solder mask defined.

⁽⁵⁾ Non-solder mask defined copper landing pad.

DIM.	MILLIMETERS ^a			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.328	0.365	0.402	0.0129	0.0144	0.0158	
A1	0.136	0.160	0.184	0.0053	0.0062	0.0072	
A2	0.192	0.205	0.218	0.0076	0.0081	0.0086	
b	0.200	0.220	0.240	0.0078	0.0086	0.0094	
b1	0.175			0.0068			
е	0.400		0.0157				
S	0.160	0.180	0.200	0.0062	0.0070	0.0078	
D	0.720	0.760	0.800	0.0283	0.0299	0.0314	
К	0.040	0.070	0.100	0.0015	0.0027	0.0039	

Note

a. Use millimeters as the primary measurement.

ECN: T15-0053-Rev. A, 16-Feb-15 DWG: 6033

Revision: 16-Feb-15

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